

FIG. 1

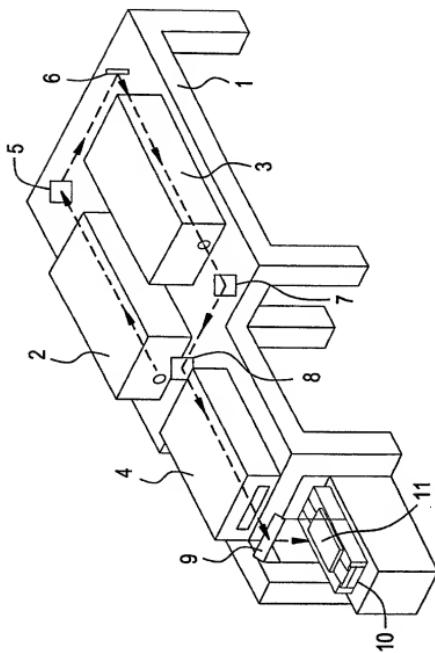


FIG. 2

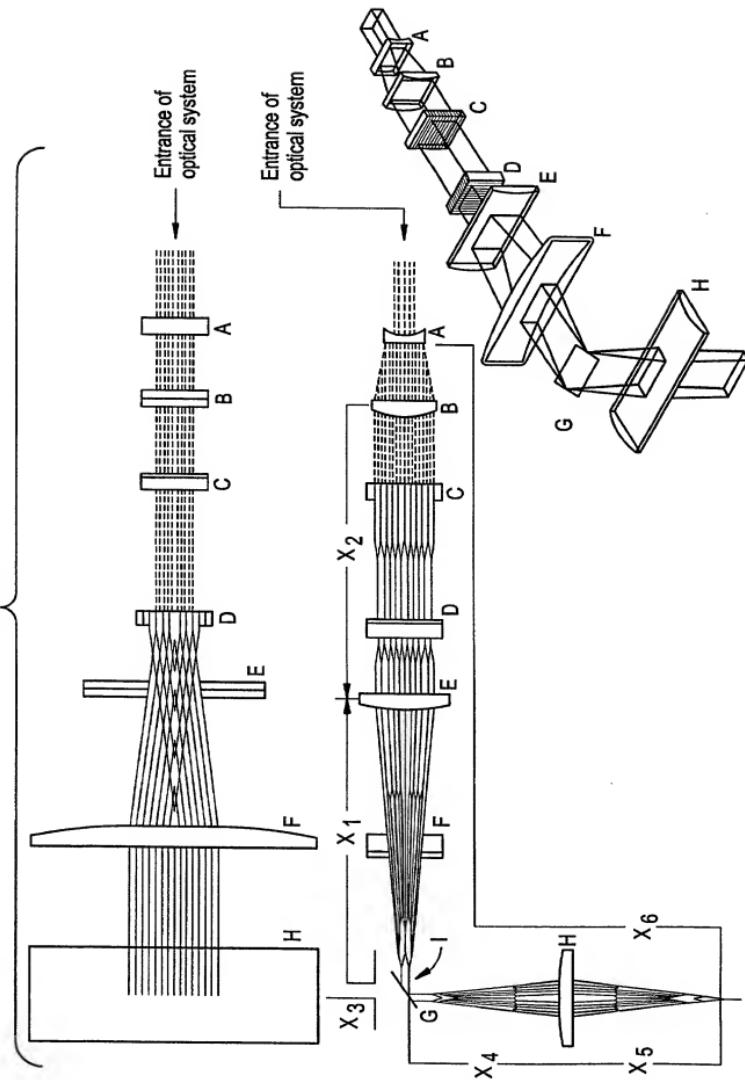


FIG. 3
PRIOR ART

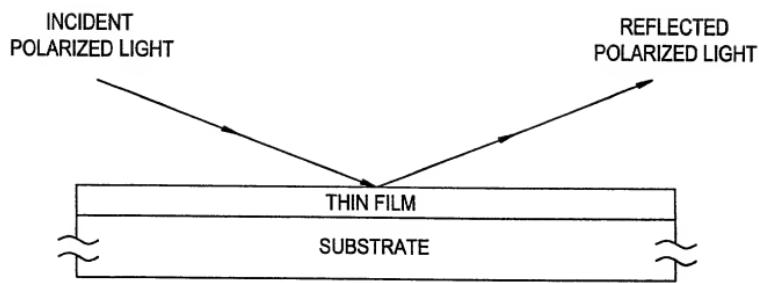


FIG. 4

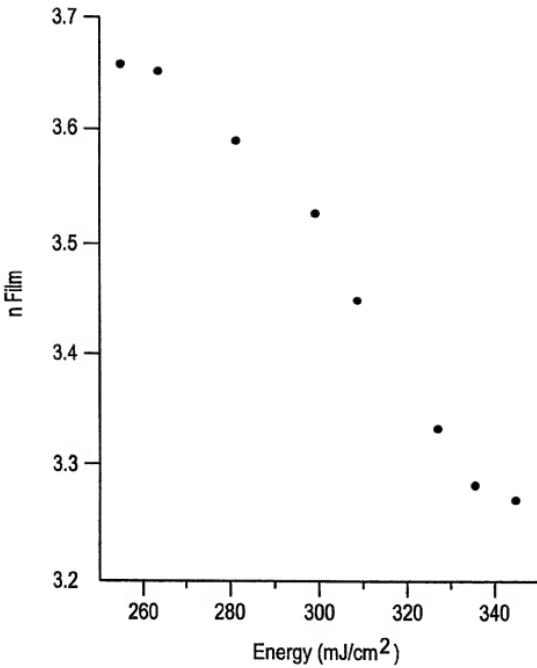


FIG. 5A

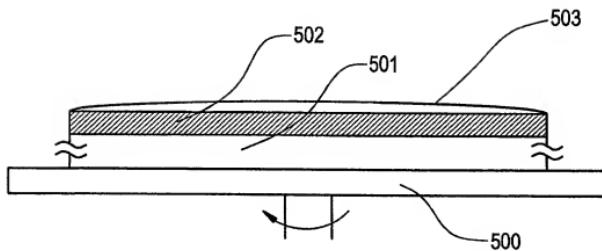


FIG. 5B

LASER LIGHT IRRADIATION

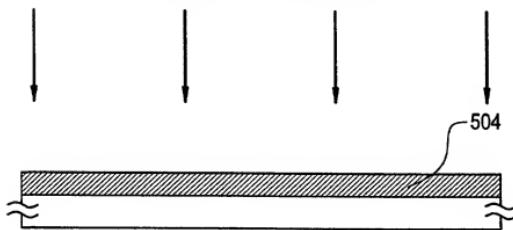


FIG. 5C

IMPURITY ION IMPLANTATION AND LASER LIGHT IRRADIATION

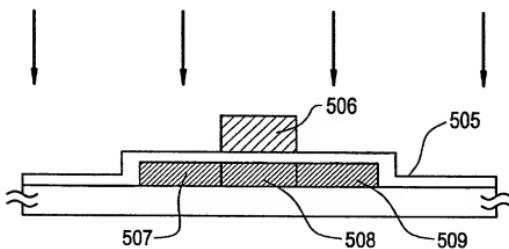


FIG. 5D

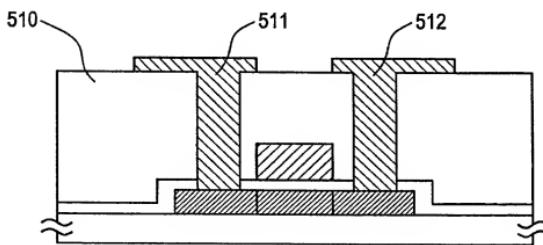


FIG. 6A

IRRADIATING LASER LIGHT TO ONE GLASS
SUBSTRATE FORMED ON CRYSTALLINE
SILICON FILM

FIG. 6B

MEASURING REFRACTIVE INDEX OF CRYSTAL-
LINE SILICON FILM TO WHICH LASER
LIGHT HAS BEEN IRRADIATED, BY ELLIPSOMETRY

FIG. 6C

INCREASING IRRADIATION ENERGY OF LASER
LIGHT, IN CASE THAT REFRACTIVE INDEX
OBTAINED BY THE FOREGOING IS LARGER
THAN PRESCRIBED REFRACTIVE INDEX

BACK TO FIG.6A

FIG. 7A

IRRADIATING LASER LIGHT TO SOURCE/DRAIN REGION OF THIN FILM TRANSISTOR FORMED ON GLASS SUBSTRATE TO PERFORM ANNEALING

FIG. 7B

IRRADIATING LASER LIGHT TO CRYSTALLINE SILICON FILM EVERY AFTER COMPLETING TREATMENT FOR ONE SUBSTRATE, AND MEASURING REFRACTIVE INDEX OF CRYSTALLINE SILICON FILM AFTER IRRADIATION, BY ELLIPSOMETRY

FIG. 7C

INCREASING IRRADIATION ENERGY OF LASER LIGHT IN CASE THAT THE FOREGOING REFRACTIVE INDEX IS LARGER THAN PRESCRIBED VALUE, AND DECREASING IRRADIATION ENERGY OF LASER LIGHT IN CASE THAT THE FOREGOING REFRACTIVE INDEX IS SMALLER THAN THE PRESCRIBED VALUE

BACK TO FIG.7A